

UTAC Selects Teradyne J750Ex-HD Extending Test Coverage for Customers

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NORTH READING, Mass.--(BUSINESS WIRE)-- [Teradyne, Inc.](#) (NYSE: TER) announced that United Test and Assembly Center, Ltd. (UTAC) selected the J750Ex-HD and placed a multi-system order to support its customers' production ramps of consumer digital devices. UTAC, a long-time J750 customer, recently adopted the system's High Density (HD) instrumentation including the 128-channel HSD800 multifunction digital instrument and HD DPS (High Density Device Power Supply) instrument, extending the range of devices tested by the system and the site count scalability available to customers.

"We have installed J750 systems across most of our facilities as they offer our customers the best value for wafer sort and a broad portfolio of instrumentation for low-end consumer A/V, baseband, FPGA and microcontroller devices," said Jim Cao, Senior Vice President of Operations, UTAC. "Adding the J750Ex-HD instrumentation to our portfolio extends the range of our test coverage and increases site count which lowers test cost for our customers, enabling them to be more cost competitive in their markets."

"The J750Ex-HD increases tester throughput through higher density instrumentation while maintaining the ease of use that people expect from the J750." said Jason Zee, Consumer Business Unit Manager at Teradyne. "Adding HD instrumentation to UTAC's portfolio extends the range of devices they can test and expands their capability to deliver low-cost production test services to their customers."

Teradyne has shipped more than 4,500 J750 family systems delivering the best cost-of-test economics for over 150 fabless and IDM semiconductor companies in low-cost consumer SoC markets including image sensor and microcontroller. Teradyne continuously invests in the platform to meet emerging test requirements enabling customers to increase test cell throughput with higher density instrumentation for increased site count. Most recently, Teradyne enhanced the system's infrastructure with improvements including a high-speed data link, and delivered a family of high-density instruments including a 48-channel DPS instrument, a 128-channel, 800Mbps multifunction instrument and a 72-channel converter test option. For more information on the J750, visit www.teradyne.com/J750/.

About UTAC Holdings Ltd

UTAC Holdings Ltd (UTAC) is a leading independent provider of semiconductor assembly and testing services for a broad range of integrated circuits including memory, mixed-signal, analog, logic and radio frequency ICs. The Company offers a full range of package and test development, engineering and manufacturing services and solutions to a worldwide customer base, comprising leading integrated device manufacturers (IDMs), fabless companies and wafer foundries. UTAC operates manufacturing facilities in Singapore, Thailand, Malaysia, Indonesia, Taiwan and China, in addition to its global network of sales offices in the United States, Europe, Japan, Korea, China and Singapore.

For more information, please visit www.utacgroup.com

About Teradyne

Teradyne (NYSE:TER) is a leading supplier of Automatic Test Equipment used to test semiconductors, wireless products, data storage and complex electronic systems which serve consumer, communications, industrial and government customers. In 2013, Teradyne had sales of \$1.43 billion and currently employs approximately 3,800 people worldwide. For more information, visit www.teradyne.com.



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